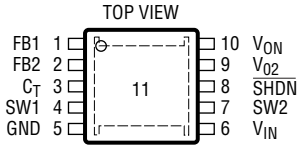
ABSOLUTE MAXIMUM RATINGS

(Note 1)

V_{IN} Voltage 8V
C_T Voltage 6V
SW1, SW2 Voltage 36V
V_{ON}, V_{O2} Voltage 30V
FB1, FB2 ..... 3V
$\overline{SHDN}$ 8V
Operating Temperature Range (Note 2) .. –40°C to 85°C
Lead Temperature (Soldering, 10 sec) ..... 300°C

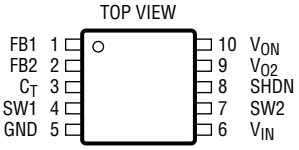
PACKAGE/ORDER INFORMATION



MSE PACKAGE
10-LEAD PLASTIC MSOP
EXPOSED PAD (PIN 11) IS GND
MUST BE SOLDERED TO PCB

T_{JMAX} = 125°C, θ_{JA} = 40°C/W

ORDER PART NUMBER
LT1947EMSE
MSE PART MARKING
LTBQW



MS PACKAGE
10-LEAD PLASTIC MSOP

T_{JMAX} = 125°C, θ_{JA} = 120°C/W

ORDER PART NUMBER
LT1947EMS
MS PART MARKING
LTUE

Order Options Tape and Reel: Add #TR, Lead Free: Add #PBF, Lead Free Tape and Reel: Add #TRPBF
Lead Free Part Marking: http://www.linear.com/leadfree/

Consult LTC Marketing for parts specified with wider operating temperature ranges.

ELECTRICAL CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T_A = 25°C. V_{IN} = 3.3V, V_{SHDN} = 3.3V unless otherwise specified.

SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
Input Voltage Range			2.7		8	V
Supply Current	SHDN = 2.4V SHDN = 0V			9.5	12.5 1	mA µA
FB1 Voltage		 ●	1.240 1.225	1.26	1.280 1.295	V V
FB2 Voltage		 ●	1.225 1.210	1.26	1.295 1.310	V V
Reference Line Regulation	V_{IN} = 2.7V to 8V			0.01	0.05	%/V

ELECTRICAL CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T_A = 25°C. V_{IN} = 3.3V, $V_{\overline{SHDN}}$ = 3.3V unless otherwise specified.

SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
Error Amplifier Voltage Gain	EA1 and EA2			100		V/V
C_T Current Source	$\overline{V_{FB1}}$ = 1.3V		4	5.5	6.5	µA
C_T Threshold to Turn On Q3			1.25	1.28	1.30	V
FB1 Voltage to Begin C_T Charge			1.17	1.2	1.23	V
SW1 Current Limit	(Note 3)		1.1	1.4	2	A
SW2 Current Limit	(Note 3)		0.35	0.6	1	A
SW1 Saturation Voltage	I_{SW1} = 800mA			0.230	0.280	V
SW2 Saturation Voltage	I_{SW2} = 300mA			0.3	0.36	V
SW1 Maximum Duty Cycle			82			%
SW2 Maximum Duty Cycle				85		%
Oscillator Frequency		●	2.3	3	3.5	MHz
V_{ON} Switch Drop	I_{Q3} = 7mA			160	200	mV
SW1 Leakage Current	Switch Off, SW1 = 3.3V			0.01	5	µA
SW2 Leakage Current	Switch Off, SW2 = 3.3V			0.01	5	µA
$\overline{SHDN}$ Pin Bias Current	$V_{\overline{SHDN}}$ = 2.4V			10	25	µA
$\overline{SHDN}$ Pin High	Active Mode		2.4			V
$\overline{SHDN}$ Pin Low	Shutdown Mode				0.4	V

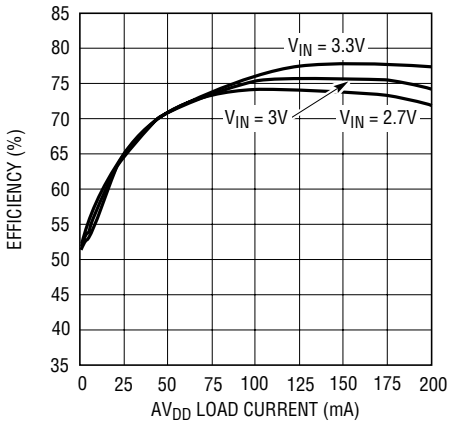
Note 1: Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.

Note 2: The LT1947 is guaranteed to meet performance specifications from 0°C to 70°C. Specifications over the –40°C to 85°C operating temperature range are assured by design, characterization and correlation with statistical process controls.

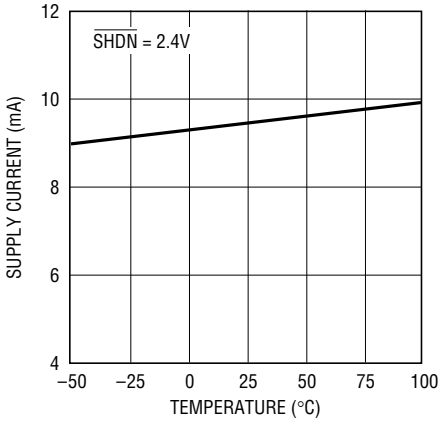
Note 3: Switch current limit guaranteed by design and/or correlation to static tests.

TYPICAL PERFORMANCE CHARACTERISTICS

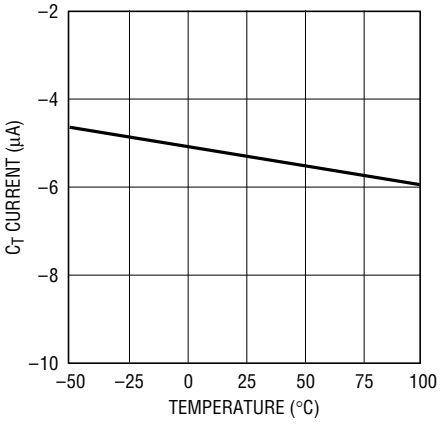
3.3V TFT-LCD Converter Efficiency



Supply Current

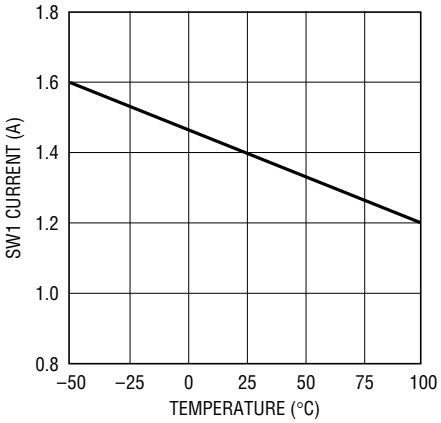


C_T Current Source

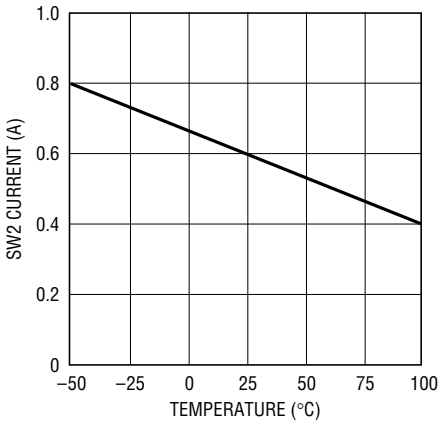


TYPICAL PERFORMANCE CHARACTERISTICS

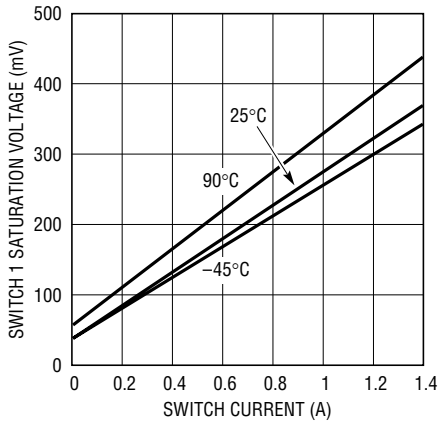
SW1 Current Limit



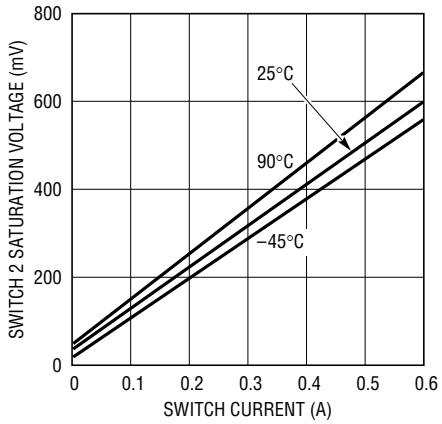
SW2 Current Limit



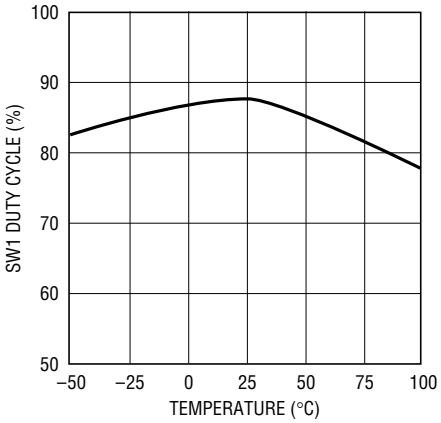
Switch 1 Saturation Voltage



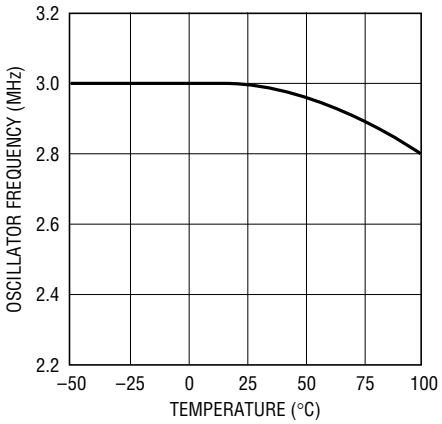
Switch 2 Saturation Voltage



SW1 Maximum Duty Cycle



Oscillator Frequency



PIN FUNCTIONS

FB1 (Pin 1): Feedback Pin for First Switcher. Connect resistor divider tap here. Set AV_{DD} according to: $AV_{DD} = 1.26V(1 + R1/R2)$.

FB2 (Pin 2): Feedback Pin for Second Switcher. Connect resistor divider 2 here and set V_{ON} using: $V_{ON} = 1.26V (1 + R3/R4) – 160mV$.

C_T (Pin 3): Timing Capacitor Pin. Connect a 10nF capacitor from C_T to ground to program a 2.3ms delay from FB1 reaching 1.26V to V_{ON} turning on.

SW1 (Pin 4): AV_{DD} Switch Node. Connect L1 and D1 here (see Figure 1). Minimize trace area at this pin to keep EMI down.

GND (Pin 5): Ground. Connect directly to local ground plane.

V_{IN} (Pin 6): Input Supply Pin. Must be bypassed with a ceramic capacitor close to the pin.

SW2 (Pin 7): V_{O2} Switch Node. Connect L2 and D2 here. Minimize trace area at this pin to keep EMI down.

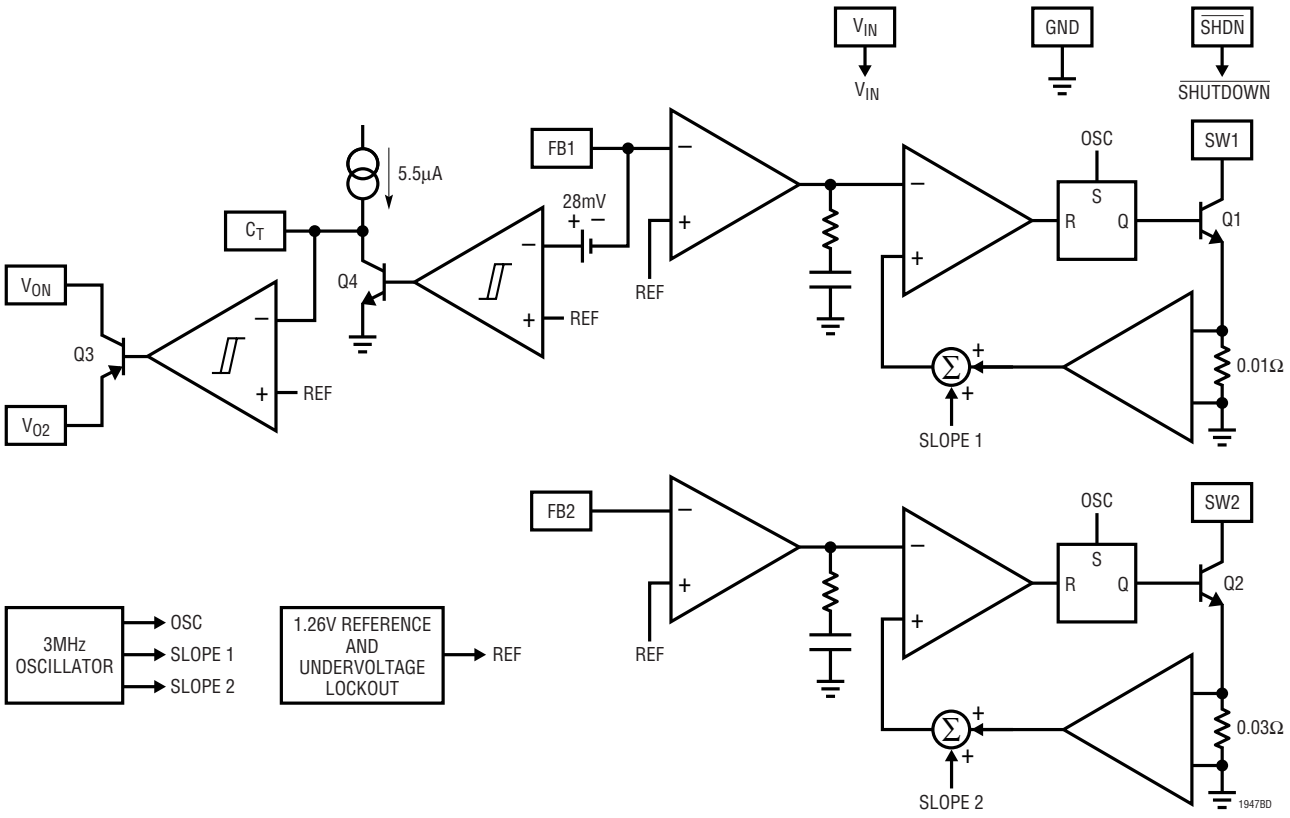
$\overline{SHDN}$ (Pin 8): Pull this pin low for shutdown mode. For normal operation, tie to a voltage between 2.4V and 8V.

V_{O2} (Pin 9): SW2 Output. This node is also internally connected to the emitter of Q3 (see Block Diagram), the high side switch between V_{O2} and V_{ON}.

V_{ON} (Pin 10): This is the delayed output for second Switcher. V_{ON} reaches its programmed voltage after the internal timer times out.

Exposed Pad (Pin 11): Ground (MSE package only). The exposed pad must be soldered to the PCB and electrically connected to ground.

BLOCK DIAGRAM



OPERATION

To best understand operation of the LT1947, please refer to the LT1947 Block Diagram. The device contains two switching regulators, a timer and a high side switch. Three outputs can be generated: an adjustable AV_{DD} output, a charge-pumped inversion of the AV_{DD} output called V_{OFF}, and a time delayed adjustable output called V_{ON}. Q3 keeps V_{ON} off for an externally set time interval, set by a capacitor connected to the C_T pin.

The switching frequency of both switchers is 3MHz, set internally. The switchers are current mode and are internally compensated. The main AV_{DD} switcher is current limited at 1.1A, while the second V_{ON} switcher is limited to 350mA. They share the same 1.26V reference voltage. When the input voltage is below approximately 2.7V, an undervoltage lockout circuit disables switching.

When AV_{DD} is less than its final voltage, Q4 is turned on, holding the C_T pin at ground. When AV_{DD} reaches final value, Q4 lets go of the C_T pin, allowing the 5.5µA current source to charge the external capacitor, C_T. When the voltage on the C_T pin reaches 1.28V, Q3 turns on, connecting V_{O2} to V_{ON}. Capacitor value can be calculated using the following formula:

$$C = (5.5\mu A \bullet t_{DELAY})/1.28V$$

A 10nF capacitor results in approximately 2.3ms of delay.

Layout Hints

The high speed operation of the LT1947 mandates careful attention to layout for proper performance. Be sure to keep input capacitor C1 as close as possible to the IC and minimize trace area and length at the SW and FB pins. Always use a ground plane under the switching regulator to minimize interplane coupling. Figure 2 shows the recommended component placement.

The exposed pad of the MSE package must be soldered to the PCB and electrically connected to ground. Thermal vias to a large ground plane will lower the thermal resistance.

Soft-Start

For applications requiring soft-start, a circuit consisting of R_{SS} and C_{SS} tied to the SHDN pin can be used, as shown in Figure 3. For a combination of 33.2k/33nF, AV_{DD} rises to its final value in approximately 3ms.

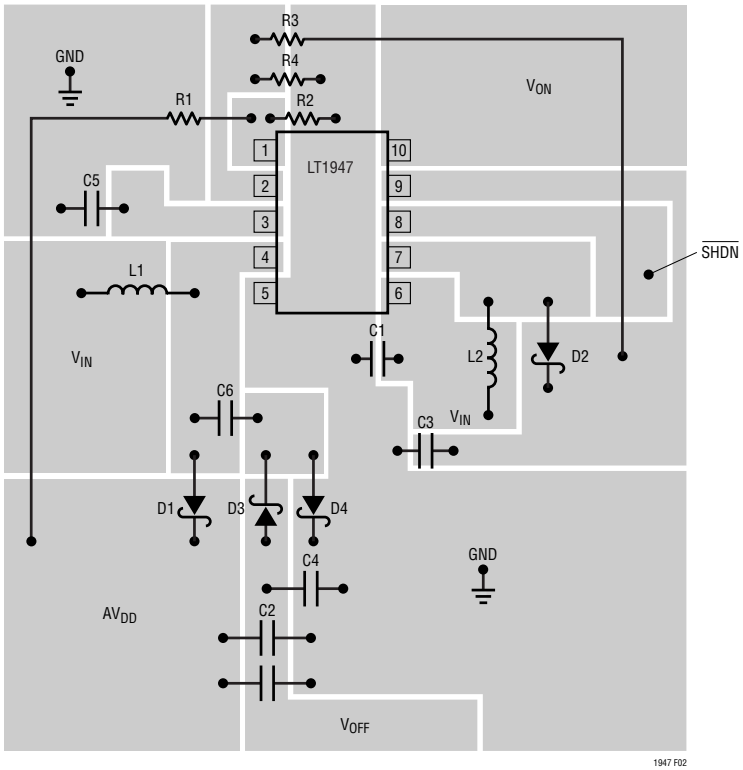
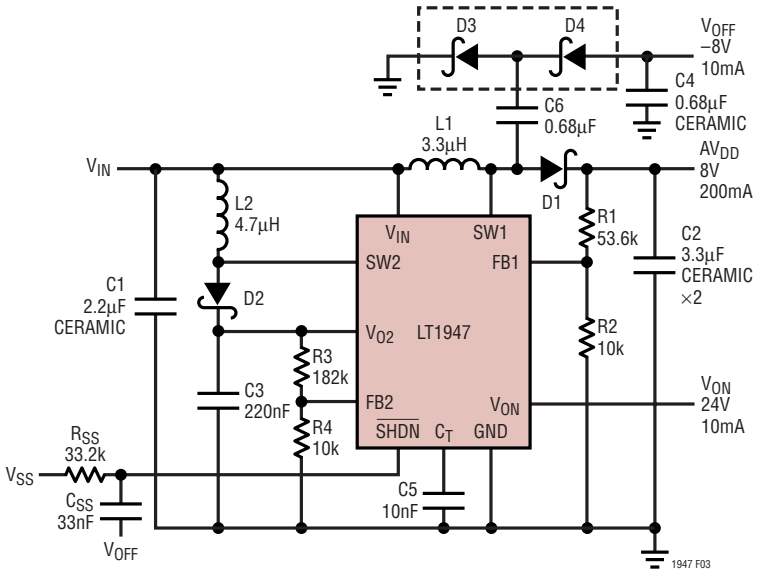


Figure 2. Recommended Component Placement

OPERATION



C1: TAIYO YUDEN LMK316BJ225MD
C2: TAIYO YUDEN LMK325BJ335MD ×2
C3: AVX 0.22µF 25V X7R
C4, C6: TAIYO YUDEN LMK107BJ684MA
D1: MBRM120LT3
D2: CMDSH-3
D3, D4: BAT54S DUAL DIODE
L1: SUMIDA CLQ4D103R3
L2: TAIYO YUDEN LB2012B4R7M

Figure 3. R_{SS} and C_{SS} at $\overline{SHDN}$ Pin Provide Soft-Start

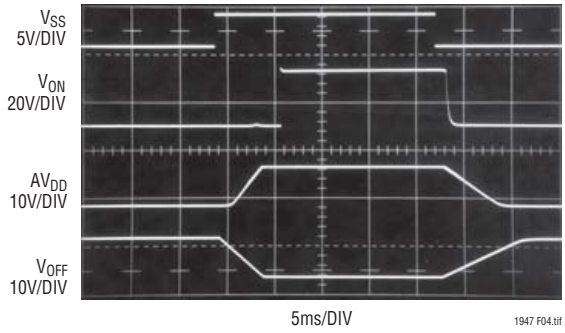
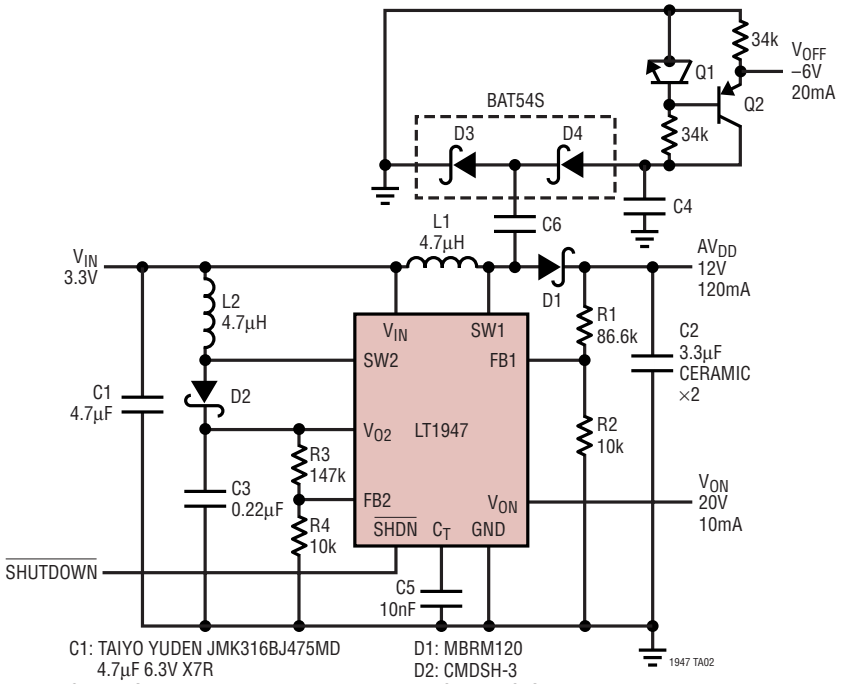


Figure 4. Start-Up Waveforms with Soft-Start Circuit Added

TYPICAL APPLICATIONS

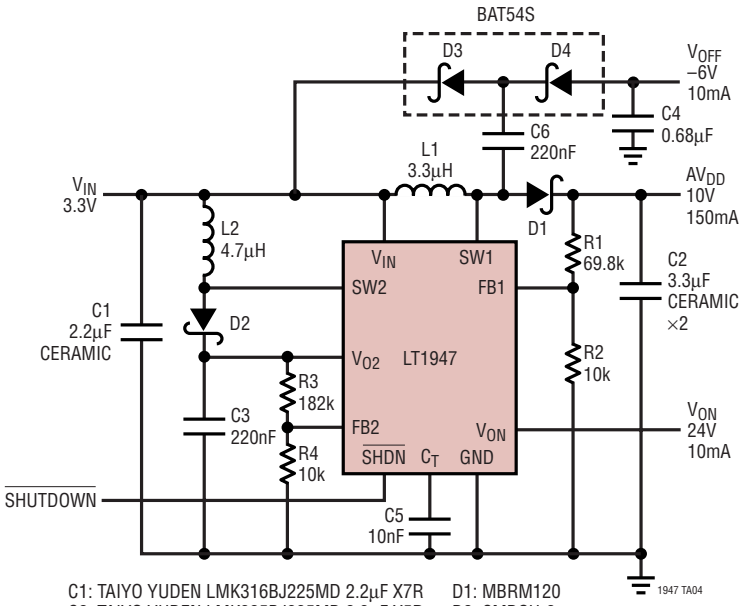
TFT-LCD Bias Generator: 12V, 20V, –6V Output



C1: TAIYO YUDEN JMK316BJ475MD
4.7µF 6.3V X7R
C2: TAIYO YUDEN LMK325BJ335MD
3.3µF 10V X7R ×2
C3: AVX 0.22µF 25V X7R
C4, C6: TAIYO YUDEN LMK107BJ684MA
0.68µF 10V X7R

D1: MBRM120
D2: CMDSH-3
L1: SUMIDA CLQ4DI04R7
L2: TAIYO YUDEN LB2012B4R7M
Q1: MMBT3904 NPN
Q2: MMBT3906 PNP

TFT-LCD Bias Generator: 10V, 24V, –6V Output

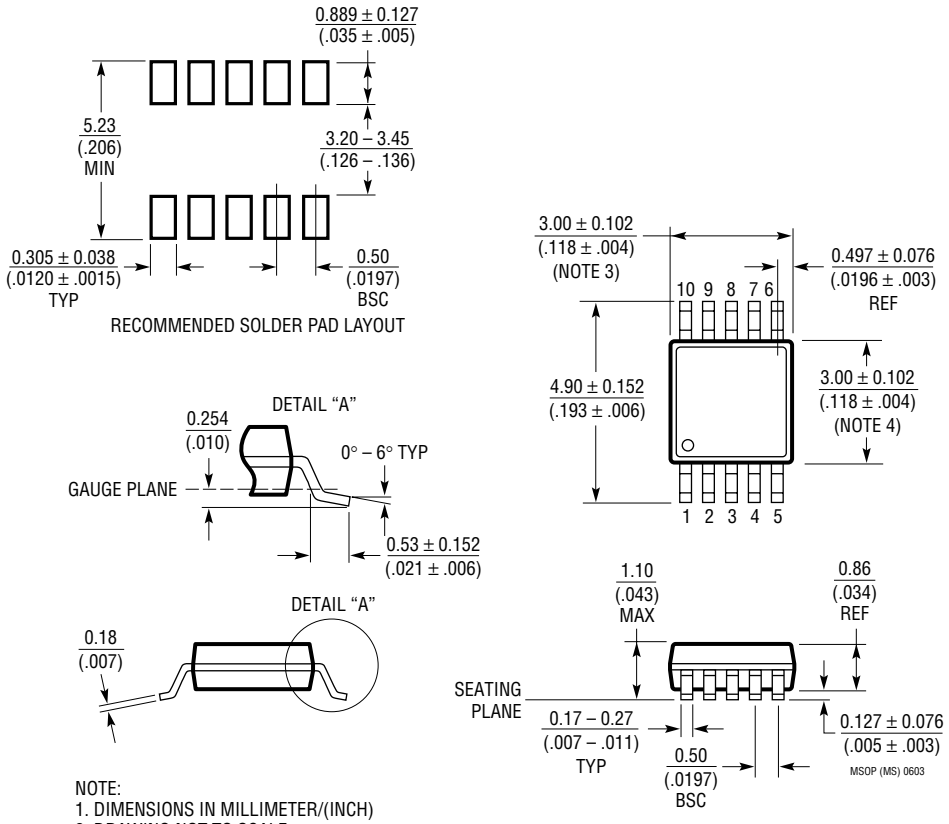


C1: TAIYO YUDEN LMK316BJ225MD 2.2µF X7R
C2: TAIYO YUDEN LMK325BJ335MD 3.3µF X5R
C3, C6: AVX 0.22µF CERAMIC X7R
C4: TAIYO YUDEN EMK212BJ684MD

D1: MBRM120
D2: CMDSH-3
L1: SUMIDA CLQ4DI03R3
L2: TAIYO YUDEN LB2012B-4R7M

PACKAGE DESCRIPTION

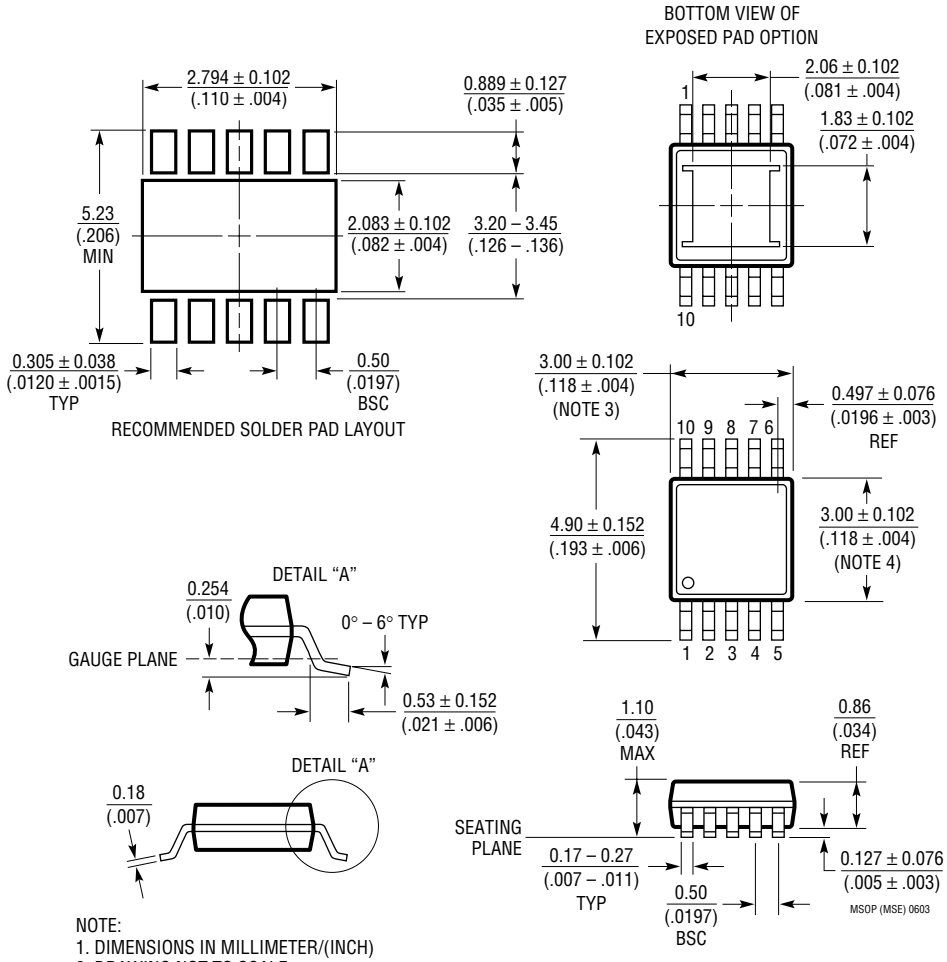
MS Package
10-Lead Plastic MSOP
(Reference LTC DWG # 05-08-1661)



NOTE:
1. DIMENSIONS IN MILLIMETER/(INCH)
2. DRAWING NOT TO SCALE
3. DIMENSION DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.
   MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.152mm (.006") PER SIDE
4. DIMENSION DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSIONS.
   INTERLEAD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.152mm (.006") PER SIDE
5. LEAD COPLANARITY (BOTTOM OF LEADS AFTER FORMING) SHALL BE 0.102mm (.004") MAX

PACKAGE DESCRIPTION

MSE Package
10-Lead Plastic MSOP
(Reference LTC DWG # 05-08-1663)



NOTE:
1. DIMENSIONS IN MILLIMETER/(INCH)
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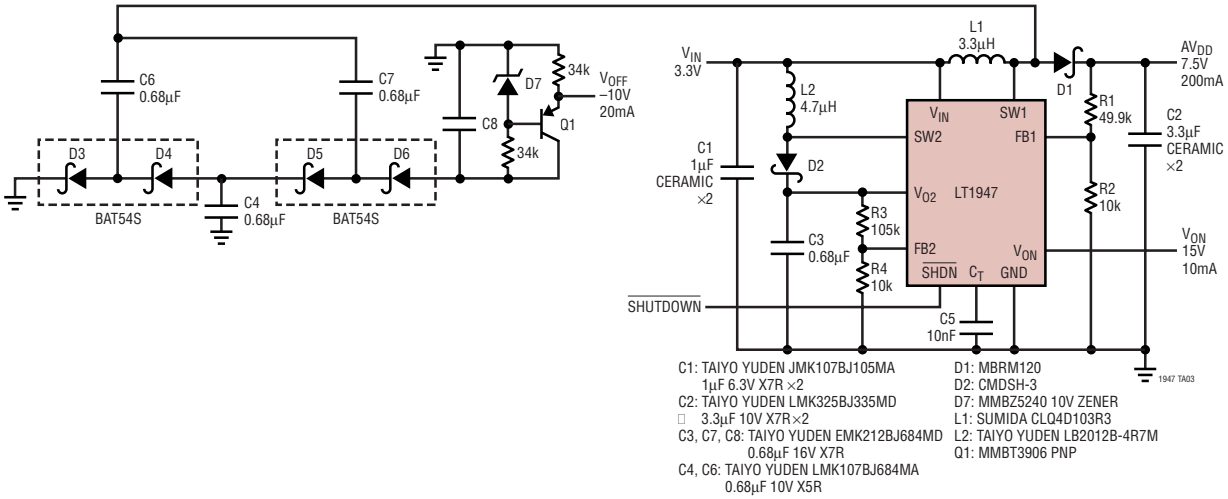
   INTERLEAD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.152mm (.006") PER SIDE
5. LEAD COPLANARITY (BOTTOM OF LEADS AFTER FORMING) SHALL BE 0.102mm (.004") MAX

TYPICAL APPLICATION

TFT-LCD Bias Generator: 7.5V, 15V, –10V Output



RELATED PARTS

PART NUMBER	DESCRIPTION	COMMENTS
LT1310	1.5A I_{SW}, 4.5MHz, High Efficiency Step-Up DC/DC Converter	V_{IN} = 2.75V to 18V, V_{OUT} Max = 35V, I_Q = 12mA, I_{SHDN} = <1µA, MS10E
LT1613	550mA I_{SW}, 1.4MHz, High Efficiency Step-Up DC/DC Converter	V_{IN} = 0.9V to 10V, V_{OUT} Max = 34V, I_Q = 3mA, I_{SHDN} = <1µA, ThinSOT
LT1615/LT1615-1	300mA/80mA I_{SW}, Constant Off-Time, High Efficiency Step-Up DC/DC Converter	V_{IN} = 1.2V to 15V, V_{OUT} Max = 34V, I_Q = 20µA, I_{SHDN} = <1µA, ThinSOT
LT1940	Dual Output 1.4A I_{OUT}, Constant 1.1MHz, High Efficiency Step-Down DC/DC Converter	V_{IN} = 3V to 25V, V_{OUT} Min = 1.2V, I_Q = 2.5mA, I_{SHDN} = <1µA, TSSOP-16E
LT1944	Dual Output 350mA I_{SW}, Constant Off-Time, High Efficiency Step-Up DC/DC Converter	V_{IN} = 1.2V to 15V, V_{OUT} Max = 34V, I_Q = 20µA, I_{SHDN} = <1µA, MS10
LT1944-1	Dual Output 150mA I_{SW}, Constant Off-Time, High Efficiency Step-Up DC/DC Converter	V_{IN} = 1.2V to 15V, V_{OUT} Max = 34V, I_Q = 20µA, I_{SHDN} = <1µA, MS10
LT1945	Dual Output, Pos/Neg 350mA I_{SW}, Constant Off-Time, High Efficiency Step-Up DC/DC Converter	V_{IN} = 1.2V to 15V, V_{OUT} Max = ±34V, I_Q = 20µA, I_{SHDN} = <1µA, MS10
LT1946/LT1946A	1.5A I_{SW}, 1.2MHz/2.7MHz, High Efficiency Step-Up DC/DC Converter	V_{IN} = 2.45V to 16V, V_{OUT} Max = 34V, I_Q = 3.2mA, I_{SHDN} = <1µA, MS8
LT1949/LT1949-1	550mA I_{SW}, 600kHz/1.1MHz, High Efficiency Step-Up DC/DC Converter	V_{IN} = 1.5V to 12V, V_{OUT} Max = 28V, I_Q = 4.5mA, I_{SHDN} = <25µA, MS8, S8
LTC3400/LTC3400B	600mA I_{SW}, 1.2MHz, Synchronous Step-Up DC/DC Converter	V_{IN} = 0.85V to 5V, V_{OUT} Max = 5V, I_Q = 19µA/300µA, I_{SHDN} = <1µA, ThinSOT
LTC3401	1A I_{SW}, 3MHz, Synchronous Step-Up DC/DC Converter	V_{IN} = 0.5V to 5V, V_{OUT} Max = 6V, I_Q = 38µA, I_{SHDN} = <1µA, MS10
LTC3402	2A I_{SW}, 3MHz, Synchronous Step-Up DC/DC Converter	V_{IN} = 0.5V to 5V, V_{OUT} Max = 6V, I_Q = 38µA, I_{SHDN} = <1µA, MS10
LTC3423	1A I_{SW}, 3MHz, Low V_{OUT}, Synchronous Step-Up DC/DC Converter	V_{IN} = 0.5V to 5V, V_{OUT} Max = 6V, I_Q = 38µA, I_{SHDN} = <1µA, MS10
LTC3424	2A I_{SW}, 3MHz, Low V_{OUT}, Synchronous Step-Up DC/DC Converter	V_{IN} = 0.5V to 5V, V_{OUT} Max = 6V, I_Q = 38µA, I_{SHDN} = <1µA, MS10

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